# 1A, Microcap, Low-Dropout, Linear Regulator

#### **ABSOLUTE MAXIMUM RATINGS**

| IN, SHDN, RST, SS to GND0.3V to +6V                   | Operating Temperature Range40°C to +85°C |
|---|--|
| OUT, SET to GND0.3V to (V <sub>IN</sub> + 0.3V)       | Junction Temperature+150°C               |
| Output Short-Circuit Duration                         | Storage Temperature Range65°C to 150°C   |
| Continuous Power Dissipation ( $T_A = +70^{\circ}C$ ) | Lead Temperature (soldering, 10s)+300°C  |
| 16-Pin TSSOP-EP (derate 26.1mW/°C above +70°C)2.0W    | Soldering Temperature (reflow)+260°C     |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = +2.7V \text{ or } V_{OUT(NOM)} + 0.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, SS = open, SET = GND, C_{OUT} = 1\mu F, T_A = 0^{\circ}C \text{ to } +85^{\circ}C,$  unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.)

| PARAMETER  | SYMBOL           | CONDITIONS   | MIN  | TYP  | MAX  | UNITS             |
|--|------------------|--|------|------|------|-------------------|
| Input Voltage Range                                    | VIN              |  | 2.7  |      | 5.5  | V                 |
| Input Undervoltage Lockout                             |                  | Typical hysteresis = 50mV  | 2.35 | 2.45 | 2.55 | V                 |
| Output Voltage Accuracy                                |                  | $I_{OUT} = 1$ mA, $T_A = +85$ °C                                   | -1   |      | 1    | %                 |
| SET Regulation Voltage (Adjustable Mode)               |                  | I <sub>OUT</sub> = 150mA, T <sub>A</sub> = +85°C                   | 792  | 800  | 808  | mV                |
| Line Regulation  | $\Delta V_{LNR}$ | $V_{IN} = V_{OUT} + 0.5V \text{ to } +5.5V, I_{OUT} = 10\text{mA}$ |      | 0.1  |      | %/V               |
| Load Regulation  | $\Delta V_{LDR}$ | I <sub>OUT</sub> = 1mA to 1A                                       |      | 0.8  | 1.5  | %/A               |
| Adjustable Output Voltage Range                        |                  |  | 0.8  |      | 5    | V                 |
| Maximum Output Current                                 | lout             | Continuous   | 1    |      |      | ARMS              |
| Short-Circuit Current Limit                            | ILIM             | V <sub>OUT</sub> = 0V  | 1.0  | 1.9  |      | Α                 |
| In-Regulation Current Limit                            | I <sub>LIM</sub> | V <sub>SET</sub> = 0.76V   | 2.0  | 4.0  |      | Α                 |
| SET Dual Mode Threshold                                |                  |  | 40   | 80   | 120  | mV                |
| SET Input Bias Current                                 | ISET             | V <sub>SET</sub> = +0.9V   |      | 50   | 300  | nA                |
| Ground Current   | 1                | Ι <sub>ΟUT</sub> = 100μΑ   |      | 0.5  | 2.0  | Λ                 |
|  | IGND             | I <sub>OUT</sub> = 1A  |      | 2.5  |      | mA                |
| Dropout Voltage  |                  | $I_{OUT} = 1 \text{mA}, +2.7 \text{V} < V_{IN} < +5.5 \text{V}$    |      | 0.2  |      | mV                |
| (Note 1)   |                  | I <sub>OUT</sub> = 1A, V <sub>OUT</sub> = +3.3V (Note 2)           |      | 200  | 350  | IIIV              |
| Output Voltage Noise                                   |                  | $f = 10Hz$ to $1MHz$ , $C_{OUT} = 1\mu F$ , $I_{OUT} = 150mA$      |      | 150  |      | μV <sub>RMS</sub> |
| Power-Supply Rejection Ratio                           | PSRR             | f = 100kHz, C <sub>OUT</sub> = 1μF                                 |      | 54   |      | dB                |
| Shutdown Supply Current                                | l <sub>OFF</sub> | $\overline{SHDN} = GND$ , $V_{IN} = +5.5V$ , $V_{OUT} = 0$         |      | 0.1  | 10   | μΑ                |
| SHDN Input Threshold                                   | V <sub>IH</sub>  | +2.7V < V <sub>IN</sub> < +5.5V                                    | 1.6  |      | 0.6  | V                 |
| SHDN Input Bias Current                                |                  | SHDN = GND or IN   |      | 0    | 0.1  | μΑ                |
| Soft-Start Charge Current                              | ISS              | V <sub>SS</sub> = 0V   |      | 6    |      | μΑ                |
| RST Output Low Voltage                                 |                  | ISINK = 1mA  |      |      | 0.1  | V                 |
| IN Operating Voltage Range for RST Valid               |                  | I <sub>SINK</sub> = 10μA   | 1.0  |      | 5.5  | V                 |
| RST Leakage  |                  | V <del>RST</del> = +5.5V   |      | 0.01 | 1    | μΑ                |
| RST Trip Level Referred to<br>Nominal V <sub>OUT</sub> |                  | Falling edge, typical hysteresis = 10mV                            | 89   | 92   | 95   | % OUT             |
| RST Release Delay                                      |                  | Rising edge  | 1    | 3    | 5.5  | ms                |
| Thermal Shutdown Threshold                             | TSHDN            | Typical thermal hysteresis = +20°C                                 |      | +170 |      | °C                |

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## 1A, Microcap, Low-Dropout, Linear Regulator

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = +2.7V \text{ or } V_{OUT(NOM)} + 0.5V \text{ (whichever is greater)}, \overline{SHDN} = IN, SS = open, SET = GND, C_{OUT} = 1\mu\text{F}, \textbf{T_A} = -40^{\circ}\textbf{C} \text{ to } +85^{\circ}\textbf{C}, \text{ unless otherwise noted.)}$ 

| PARAMETER  | SYMBOL           | CONDITIONS  | MIN | MAX | UNITS |
|--|------------------|---|-----|-----|-------|
| Input Voltage Range                                    | VIN              |   | 2.7 | 5.5 | V     |
| Input Undervoltage Lockout                             |                  | Typical hysteresis = 50mV                             | 2.3 | 2.6 | V     |
| Output Voltage Accuracy                                |                  | $I_{OUT} = 1$ mA, $T_A = +85$ °C                      | -1  | 1   | %     |
| SET Regulation Voltage (Adjustable Mode)               |                  | I <sub>OUT</sub> = 150mA, T <sub>A</sub> = +85°C      | 792 | 808 | mV    |
| Load Regulation  | $\Delta V_{LDR}$ | I <sub>OUT</sub> = 1mA to 1A                          |     | 2.0 | %/A   |
| Adjustable Output Voltage Range                        |                  |   | 0.8 | 5   | V     |
| Maximum Output Current                                 | lout             | Continuous  | 1   |     | ARMS  |
| Short-Circuit Current Limit                            | I <sub>LIM</sub> | V <sub>OUT</sub> = 0V                                 | 1.0 |     | Α     |
| In-Regulation Current Limit                            | I <sub>LIM</sub> | $V_{SET} = +0.76V$                                    | 2.0 |     | А     |
| SET Dual Mode Threshold                                |                  |   | 40  | 120 | mV    |
| SET Input Bias Current                                 | ISET             | $V_{SET} = +0.9V$                                     |     | 300 | nA    |
| Ground Current   | IGND             | $I_{OUT} = 100\mu A$                                  |     | 2.0 | mA    |
| Dropout Voltage (Note 1)                               |                  | $I_{OUT} = 1A$ , $V_{OUT} = +3.3V$ (Note 2)           |     | 350 | mV    |
| Shutdown Supply Current                                | I <sub>OFF</sub> | $\overline{SHDN} = GND, V_{IN} = +5.5V, V_{OUT} = 0V$ |     | 10  | μΑ    |
| SHDN Input Threshold                                   | VIH              | +2.7V < V <sub>IN</sub> < +5.5V                       | 1.7 |     | V     |
| SHDIN INPUT MIESHOID                                   | VIL              |   |     | 0.6 | v     |
| SHDN Input Bias Current                                |                  | SHDN = GND or IN                                      |     | 0.1 | μΑ    |
| RST Output Low Voltage                                 |                  | ISINK = 1mA   |     | 0.1 | V     |
| IN Operating Voltage Range for RST Valid               |                  | ISINK = 10µA  | 1.0 | 5.5 | V     |
| RST Leakage  |                  | $V_{\overline{RST}} = +5.5V$                          |     | 1   | μΑ    |
| RST Trip Level Referred to<br>Nominal V <sub>OUT</sub> |                  | Falling edge, typical hysteresis = 10mV               | 88  | 95  | % OUT |
| RST Release Delay                                      |                  | Rising edge   | 1   | 6   | ms    |

Note 1: Dropout voltage is  $(V_{IN} - V_{OUT})$  when  $V_{OUT}$  falls to 100mV below the value of  $V_{OUT}$  measured when  $V_{IN} = V_{OUT}(NOM) + 0.5V$ . Since the minimum input voltage is 2.7V, this specification is only meaningful when  $V_{OUT} \ge 2.7V$ .

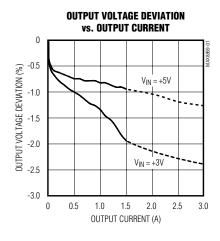
Note 2: The output voltage is externally set using a resistive voltage-divider from OUT to SET.

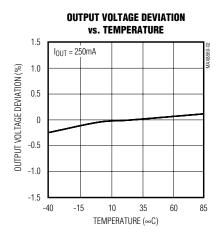
Note 3: Specifications to -40°C are guaranteed by design, not production tested.

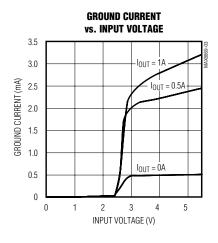
# 1A, Microcap, Low-Dropout, Linear Regulator

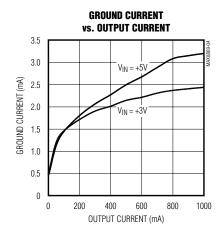
## **Typical Operating Characteristics**

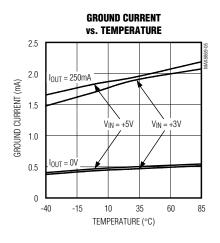
(VIN = +5V, VOUT = +2.5V, SHDN = IN, SS = open, COUT = 1μF, TA = +25°C, unless otherwise noted.)

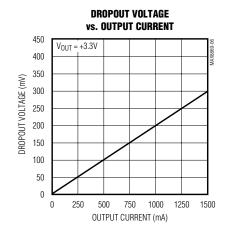


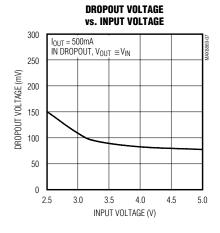


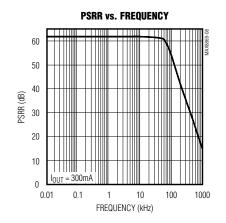


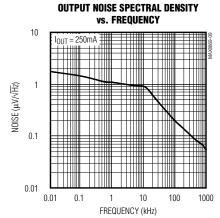








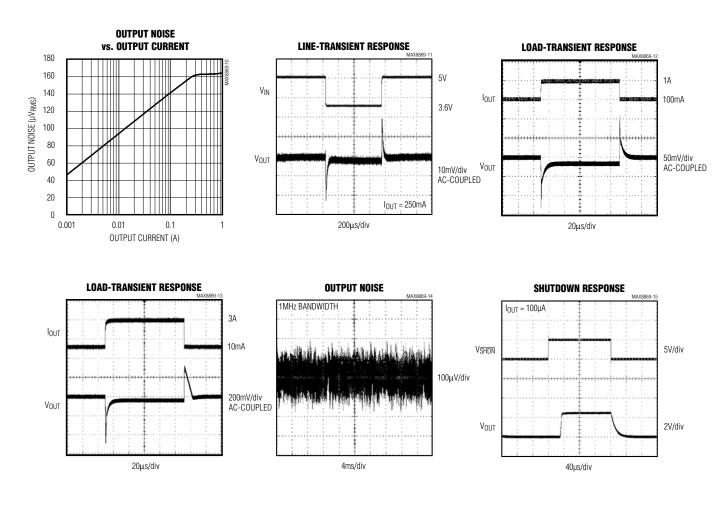


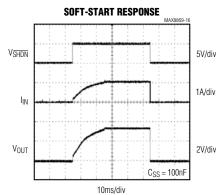


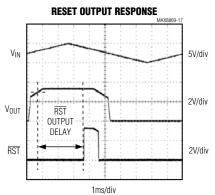
# 1A, Microcap, Low-Dropout, Linear Regulator

## **Typical Operating Characteristics (continued)**

 $(V_{IN} = +5V, V_{OUT} = +2.5V, \overline{SHDN} = IN, SS = open, C_{OUT} = 1\mu F, T_A = +25^{\circ}C, unless otherwise noted.)$ 







# 1A, Microcap, Low-Dropout, Linear Regulator

#### **Pin Description**

| PIN            | NAME | FUNCTION  |
|----------------|------|---|
| 1, 9, 16       | N.C. | No Connection. Not internally connected.  |
| 2, 3, 4, 5     | IN   | Regulator Input. Connect to power source ( $\pm 2.7 \text{V}$ to $\pm 5.5 \text{V}$ ). Bypass with $1 \mu \text{F}$ or greater capacitor to GND (see <i>Capacitor Selection and Regulator Stability</i> ). Connect all IN inputs together for proper operation.   |
| 6              | RST  | Reset Output. Open-drain output is low when $V_{OUT}$ is 8% below its nominal value. $\overline{RST}$ remains low while the output voltage ( $V_{OUT}$ ) is below the reset threshold and for at least 3ms after $V_{OUT}$ rises to within regulation. Connect a $100k\Omega$ pullup resistor to OUT to obtain an output voltage. |
| 7              | SHDN | Active-Low Shutdown Input. A logic low reduces the supply current to 0.1µA. Connect \$\overline{SHDN}\$ to IN for normal operation. In shutdown, \$\overline{RST}\$ is low and the soft-start capacitor discharges.   |
| 8              | SS   | Soft-Start Control. Connect a soft-start capacitor from SS to GND (see <i>Soft-Start Capacitor Selection</i> ). Leave SS open to disable soft-start.  |
| 10             | GND  | Ground. Solder both GND and EP to a large pad or to the circuit-board ground plane to maximize power dissipation.   |
| 11             | SET  | Voltage-Setting Input. Connect SET to GND for factory-preset output voltage. Connect SET to an external resistor-divider for adjustable output operation.   |
| 12, 13, 14, 15 | OUT  | Regulator Output. Bypass with a 1µF or greater low-ESR capacitor to GND (see <i>Capacitor Selection and Regulator Stability</i> ). Connect all OUT outputs together for proper operation.   |
| _              | EP   | Exposed Pad. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point.   |

## Detailed Description

The MAX8869 features Dual Mode operation, allowing a fixed output of +5V, +3.3V, +2.5V, +1.8V, or +1.0V, or adjustable output from +0.8V to +5.0V. The regulators are guaranteed to supply 1A of continuous output current with only  $1\mu F$  of output capacitance.

As shown in the functional diagram (Figure 1), the device has a 0.8V reference, error amplifier, MOSFET driver, P-channel pass transistor, internal feedback voltage-divider, soft-start function, reset timer, and Dual Mode and low VOUT comparators.

The 0.8V reference is connected to the error amplifier's inverting input. The error amplifier compares this reference with the selected feedback voltage and amplifies the difference. The MOSFET driver reads the error signal and applies the appropriate drive to the P-channel transistor. If the feedback voltage is high, the pass transistor's gate is pulled up, allowing less current to pass to the output. The low Vout comparator senses when

the feedback voltage has dropped 8% below its expected level, causing RST to go low.

The output voltage is fed back through either an internal resistor-divider connected to OUT or an external resistor network connected to SET. The Dual Mode comparator examines V<sub>SET</sub> and selects the feedback path. If V<sub>SET</sub> is below 80mV, the internal feedback path is used and the output voltage is regulated to the factory-preset voltage. Otherwise, the output voltage is set with the external resistor-divider.

#### **Internal P-Channel Pass Transistor**

The MAX8869 features a 1A P-channel MOSFET pass transistor. Unlike similar designs using PNP pass transistors, P-channel MOSFETs require no base drive, which reduces quiescent current. PNP-based regulators also waste considerable current in dropout when the pass transistor saturates and use high base-drive currents under large loads. The MAX8869 does not suffer from these problems and consumes only 500µA of quiescent current even in dropout.

## 1A, Microcap, Low-Dropout, Linear Regulator

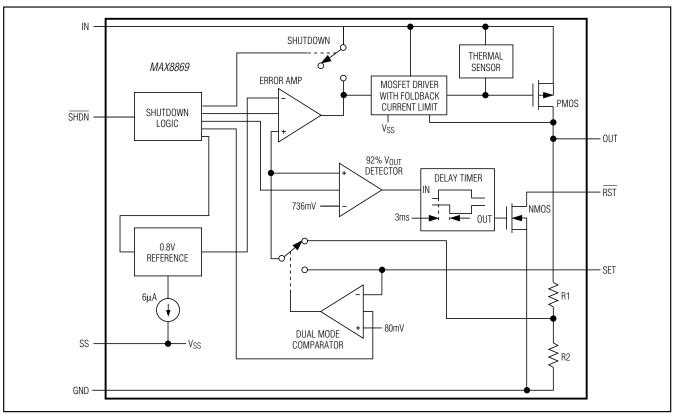


Figure 1. Functional Diagram

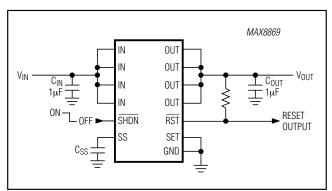


Figure 2. Typical Operating Circuit with Preset Output Voltage

#### **Output Voltage Selection**

The MAX8869 features Dual Mode operation. Connect SET to GND (Figure 2) for preset voltage mode (see *Ordering Information*). In adjustable mode, set the output between +0.8V to +5.0V through two external resistors connected as a voltage-divider to SET (Figure 3). The output voltage is set by the following equation:

$$VOUT = VSET (1 + R1 / R2)$$

where  $V_{SET} = +0.8V$ . To simplify resistor selection:

$$R1 = R2 (VOUT / VSET - 1)$$

Since the input bias current at SET is nominally 50nA, large resistance values can be used for R1 and R2 to minimize power consumption without losing efficiency. Up to  $80k\Omega$  is acceptable for R2.

In preset voltage mode, the impedance between SET and ground should be less than  $10k\Omega$ . Otherwise, spurious conditions could cause the voltage at SET to exceed the 80mV Dual Mode threshold.

#### Shutdown

A logic low on  $\overline{SHDN}$  disables the MAX8869. In shutdown, the pass transistor, control circuitry, reference, and all biases are turned off, reducing supply current to typically 0.1µA. Connect  $\overline{SHDN}$  to IN for normal operation. In shutdown,  $\overline{RST}$  is low and the soft-start capacitor is discharged.

#### **RST** Comparator

The MAX8869 features a low  $V_{OUT}$  indicator that asserts when the output voltage falls out of regulation. The open-drain  $\overline{RST}$  goes low when OUT falls 8%

# 1A, Microcap, Low-Dropout, Linear Regulator

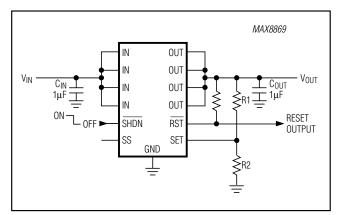


Figure 3. Typical Operating Circuit with Adjustable Output Voltage

below its nominal output voltage.  $\overline{RST}$  remains low for 3ms after OUT has returned to its nominal value. A 100k $\Omega$  pullup resistor from  $\overline{RST}$  to a suitable logic supply voltage (typically OUT) provides a logic control signal.  $\overline{RST}$  can be used as a power-on-reset signal to a microcontroller ( $\mu$ C) or can drive an external LED for indicating a power failure.  $\overline{RST}$  is low during shutdown.  $\overline{RST}$  remains valid for an input voltage as low as 1V.

#### Soft-Start

As shown in Figure 4, a capacitor on SS allows a gradual buildup of the MAX8869 output, reducing the initial in-rush current peaks at startup. When  $\overline{SHDN}$  is driven low, the soft-start capacitor is discharged. When  $\overline{SHDN}$  is driven high or power is applied to the device, a constant 6µA current charges the soft-start capacitor. The resulting linear ramp voltage on SS increases the current-limit comparator threshold, limiting the P-channel gate drive (see <code>Soft-Start Capacitor Selection</code>). Leave SS unconnected to disable the soft-start feature.

#### **Current Limiting**

The MAX8869 features a 4A current limit when the output voltage is in regulation. When the output voltage drops by 8% below its nominal, the current limit folds back to 1.7A. The output can be shorted to ground for an indefinite period of time without damaging the device. Avoid continuous output current of more than 1A to prevent damage.

Both the in-regulation and short-circuit current limits can be reduced from their nominal values by reducing the voltage at the soft-start input (SS) below 1.25V. The current limits scale proportionately with the voltage by  $I_{LIM} = I_{LIM\_NOM} \times (V_{SS} / 1.25)$ . Since the SS input sources a nominal 6µA current, the current limit can be set by

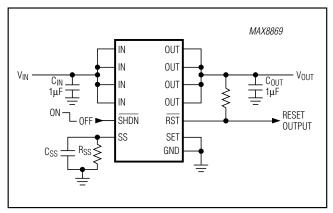


Figure 4. Typical Operating Circuit with Soft-Start and Current-Limit Reduction

tying a resistor (Rss) between SS and GND, so that I<sub>LIM</sub> = I<sub>LIM\_NOM</sub> × (Iss × Rss / 1.25) where Iss = 6 $\mu$ A . With Rss in place, soft-start can still be achieved by placing a capacitor (Css) in parallel with Rss. The output current now ramps up asymptotically to the reduced current limit rather than the nominal one, increasing the soft-start time. The time required for the current limit to reach 90% of its steady-state value is given by tss = 2.3 RssCss.

#### **Thermal Overload Protection**

Thermal overload protection limits total power dissipation in the MAX8869. When the junction temperature exceeds  $T_J = +170^{\circ}\text{C}$ , the thermal sensor turns off the pass transistor, allowing the IC to cool. The thermal sensor turns the pass transistor on once the IC's junction temperature drops approximately 20°C. Continuous short-circuit conditions will consequently result in a pulsed output.

Thermal overload protection is designed to safeguard the MAX8869 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction temperature rating of  $T_{J} = +150^{\circ}C$ .

#### **Operating Region and Power Dissipation**

Maximum power dissipation of the MAX8869 depends on the thermal resistance of the case and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow. The power dissipation across the device is  $P = I_{OUT} (V_{IN} - V_{OUT})$ . The resulting maximum power dissipation is:

$$P_{MAX} = [(T_{J(MAX)} - T_{A}) / (\theta_{JC} + \theta_{CA})]$$

where  $(T_{J(MAX)} - T_A)$  is the temperature difference between the maximum allowed die junction (150°C) and the surrounding air;  $\theta_{JC}$  (junction to case) is the

## 1A, Microcap, Low-Dropout, Linear Regulator

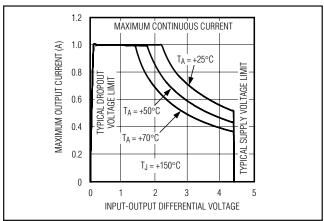


Figure 5. Power Operating Region: Maximum Output Current vs. Input-Output Differential Voltage

thermal resistance of the package chosen, and  $\theta_{CA}$  is the thermal resistance from the case through the PC board, copper traces, and other materials to the surrounding air. Figure 5 shows the allowable power dissipation for typical PC boards at +25°C, +50°C, and +70°C ambient temperatures.

The MAX8869 TSSOP-EP package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct thermal heat path from the die to the PC board. Additionally, GND also channels heat. Connect the exposed thermal pad and GND to circuit ground by using a large pad (1in² minimum recommended) or multiple vias to the ground plane.

## Applications Information

#### Capacitor Selection and Regulator Stability

Capacitors are required at the MAX8869 input and output. Connect  $1\mu F$  or greater capacitors between IN and GND ( $C_{IN}$ ) and OUT and GND ( $C_{OUT}$ ). Due to the MAX8869's relatively high bandwidth, use only surface-mount ceramic capacitors that have low equivalent series resistance (ESR) and high self-resonant frequency (SRF). Make the input and output traces at least 2.5mm wide (the width of the four parallel inputs and outputs), and connect  $C_{IN}$  and  $C_{OUT}$  within 6mm of the IC to minimize the impact of PC board trace inductance. The width of the ground trace should be maximized underneath the IC to ensure a good connection between GND and the ground side of the capacitors.

The output capacitor's ESR and SRF can affect stability and output noise. Use capacitors with greater than 5MHz

SRF and ESR of  $60m\Omega$  or less to ensure stability and optimum transient response. This is particularly true in applications with very low output voltage (<2V) and high output current (>0.5A).

Since some capacitor dielectrics may vary over bias voltage and temperature, consult the capacitor manufacturer specifications to ensure that the capacitors meet these requirements over all voltage and temperature conditions used.

#### **Soft-Start Capacitor Selection**

A capacitor (Css) connected from SS to GND causes the MAX8869 output current to slowly rise during startup, reducing stress on the input supply. The rise time to full current limit (tss) is determined by:

$$tss = 2.08 \times 10^{-4} \times Css$$

where Css is in nF. Typical capacitor values between 10nF to 100nF, with a 5V rating, are sufficient.

Because this ramp is applied to the current-limit comparator, the actual time for the output voltage to ramp up depends on the load current and output capacitor. Leave SS open to disable soft-start.

#### Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this determines the useful end-of-life battery voltage. Since a  $0.2\Omega$  P-channel MOSFET is used as the pass device, dropout voltage is the product of  $R_{DS(ON)}$  and load current (see  $\it Electrical\ Characteristics\$ and Dropout Voltage vs. Output Current in  $\it Typical\ Operating\ Characteristics\$ ). The MAX8869 operating current remains low in dropout.

#### Noise, PSRR, and Transient Response

The MAX8869 is designed to achieve low dropout voltage and low quiescent current in battery-powered systems while still maintaining good noise, transient response, and AC rejection (see PSRR vs. Frequency in the *Typical Operating Characteristics*). When operating from very noisy sources, supply noise rejection and transient response can be improved by increasing the values of the input and output capacitors and employing passive postfiltering. MAX8869 output noise is typically 150µVRMS. (see the Output Noise plot in the *Typical Operating Characteristics*).

PROCESS: BiCMOS

# 1A, Microcap, Low-Dropout, Linear Regulator

**Chip Information** 

### Package Information

For the latest package outline information and land patterns (footprints), go to <a href="www.maximintegrated.com/package">www.maximintegrated.com/package</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE  | PACKAGE | OUTLINE | LAND        |
|----------|---------|---------|-------------|
| TYPE     | CODE    | NO.     | PATTERN NO. |
| 16 TSSOP | U16E+3  | 21-0108 | 90-0120     |

# 1A, Microcap, Low-Dropout, Linear Regulator

### **Revision History**

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION  | PAGES<br>CHANGED |  |
|--------------------|------------------|--|------------------|--|
| 0                  | 8/00             | Initial release  | _                |  |
| 1                  | 6/10             | Added lead-free versions to <i>Ordering Information</i> , updated Continuous Power Dissipation and added Soldering Temperature to <i>Absolute Maximum Ratings</i> , and added EP row to <i>Pin Description</i> | 1, 2, 6          |  |
| 2                  | 10/12            | Added automotive qualified part to Ordering Information  | 1                |  |



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11